

UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 6,890,794 B2  
APPLICATION NO. : 10/765811  
DATED : May 10, 2005  
INVENTOR(S) : Eran Rotem

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

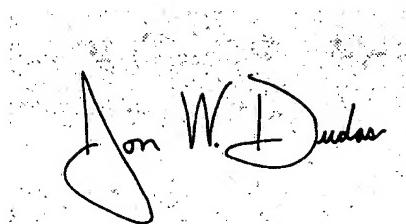
**ON THE PATENT FACE**

In the Abstract, (57) Line 4: Delete "including" after "die"

Title: (54) Delete "FLIP CHIP WITH NOVEL POWER AND GROUND  
ARRANGEMENT" and insert -- METHOD OF FORMING A  
FLIP CHIP --

Signed and Sealed this

Twenty-first Day of November, 2006



JON W. DUDAS  
*Director of the United States Patent and Trademark Office*